

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of :  
Takeshi HASHIMOTO et al. :  
Serial No. [NEW] : **Attn: Application Branch**  
Filed December 31, 2001 : **Attorney Docket No. 2001-1790**  
THERMOSETTING LOW-DIELECTRIC :  
RESIN COMPOSITION AND USE :  
THEREOF :  
**(Rule 1.53(b) Divisional of Serial No. 09/433,281, Filed November 3, 1999)**

J1046 U.S. PTO  
10/029991  
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THE COMMISSIONER IS AUTHORIZED  
TO CHARGE ANY DEFICIENCY IN THE  
FEE FOR THIS PAPER TO DEPOSIT  
ACCOUNT NO. 23-0975.

**CLAIM OF PRIORITY UNDER 35 USC 119**

Assistant Commissioner for Patents,  
Washington, DC 20231

Sir:

Applicants in the above-entitled application hereby claim the date of priority under the International Convention of Japanese Patent Application No. 331977/98, filed November 6, 1998, Japanese Patent Application No. 331978/98, filed November 6, 1998, Japanese Patent Application No. 331979/98, filed November 6, 1998, and Japanese Patent Application No. 331980/98, filed November 6, 1998, as acknowledged in the Declaration of this application.

Certified copies of said Japanese Patent Applications are of record in parent application Serial No. 09/433,281, filed November 3, 1999.

Respectfully submitted,

Takeshi HASHIMOTO et al.

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December 31, 2001